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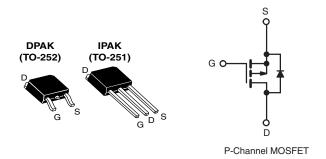
Vishay Siliconix

COMPLIANT HALOGEN

FREE

Power MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	- 200			
R _{DS(on)} (Ω)	V _{GS} = - 10 V 1.5			
Q _g (Max.) (nC)	20			
Q _{gs} (nC)	3.3			
Q _{gd} (nC)	11			
Configuration	Single			



FEATURES

- Dynamic dV/dt Rating
- Repetitive Avalanche Rated
- Surface Mount (IRFR9220, SiHFR9220)
- Straight Lead (IRFUFU9220, SiHFU9220)
- Available in Tape and Reel
- P-Channel
- Fast Switching
- Material categorization: For definitions of compliance please see www.vishay.com/doc?99912



DESCRIPTION

Third power MOSFETs technology is the key to Vishay advanced line of Power MOSFET transistors. The efficient geometry and unique processing of the Power MOSFETs design achieve very low on-state resistance combined with high transconductance and extreme device ruggedness. The DPAK is designed for surface mounting using vapor phase, infrared, or wave soldering techniques. The straight lead version (IRFU, SiHFU series) is for through-hole mounting applications. Power dissipation levels up to 1.5 W are possible in typical surface mount applications.

ORDERING INFORMATION						
Package	DPAK (TO-252)	DPAK (TO-252)	DPAK (TO-252)	DPAK (TO-252)	IPAK (TO-251)	
Lead (Pb)-free and Halogen-free	SiHFR9220-GE3	SiHFR9220TRL-GE3a	SiHFR9220TRR-GE3ª	SiHFR9220TR-GE3ª	SiHFU9220-GE3	
Load (Db) from	IRFR9220PbF	IRFR9220TRLPbFa	IRFR9220TRRPbFa	IRFR9220TRPbFa	IRFU9220PbF	
Lead (Pb)-free	SiHFR9220-E3	SiHFR9220TL-E3a	SiHFR9220TR-E3 ^a	SiHFR9220T-E3 ^a	SiHFU9220-E3	

Note

a. See device orientation.

ABSOLUTE MAXIMUM RATINGS (To	$_{\rm C}$ = 25 °C, unl	ess otherwis	se noted)			
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V _{DS}	- 200	.,	
Gate-Source Voltage			V_{GS}	± 20	V	
Continuous Drain Current	V at 10 V	$T_C = 25 ^{\circ}C$ $T_C = 100 ^{\circ}C$		- 3.6		
Continuous Drain Current	VGS at - 10 V	T _C = 100 °C	Ι _D	- 2.3	Α	
Pulsed Drain Current ^a			I _{DM}	- 14		
Linear Derating Factor				0.33	W/°C	
Linear Derating Factor (PCB Mount)e				0.020	W/°C	
Single Pulse Avalanche Energy ^b			E _{AS}	310	mJ	
Repetitive Avalanche Current ^a			I _{AR}	- 3.6	А	
Repetitive Avalanche Energy ^a			E _{AR}	4.2	mJ	
Maximum Power Dissipation $T_C = 25 ^{\circ}C$			-	42	W	
Maximum Power Dissipation (PCB Mount) ^e			P_D	2.5	\ \v	
Peak Diode Recovery dV/dt ^c			dV/dt	- 5.0	V/ns	
Operating Junction and Storage Temperature Range			T _J , T _{stg}	- 55 to + 150	- °C	
Soldering Recommendations (Peak Temperature)d	for	for 10 s		260	1	

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- $V_{DD}=-50$ V, Starting T_J = 25 °C, L = 35 mH, R_g = 25 Ω , I_{AS} = 3.6 A (see fig. 12). I_{SD} \leq 3.9 A, dl/dt \leq 95 A/µs, V_{DD} \leq V_{DS}, T_J \leq 150 °C. 1.6 mm from case.

- When mounted on 1" square PCB (FR-4 or G-10 material).

IRFR9220, IRFU9220, SiHFR9220, SiHFU9220

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THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT
Maximum Junction-to-Ambient	R _{thJA}	-	-	110	
Maximum Junction-to-Ambient (PCB Mount) ^a	R _{thJA}	-	-	50	°C/W
Maximum Junction-to-Case (Drain)	R _{thJC}	-	-	3.0	

Note

a. When mounted on 1" square PCB (FR-4 or G-10 material).

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static							
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$		- 200	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C, I _D = - 1 mA	-	- 0.22	-	V/°C
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} =	V _{GS} , I _D = - 250 μA	- 2.0	-	- 4.0	V
Gate-Source Leakage	I _{GSS}		V _{GS} = ± 20 V	-	-	± 100	nA
Zero Gate Voltage Drain Current	I _{DSS}		- 200 V, V _{GS} = 0 V V, V _{GS} = 0 V, T _J = 125 °C	-	-	- 100 - 500	μA
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = - 10 V	1	-	-	1.5	Ω
Forward Transconductance	9 _{fs}	V _{DS} =	- 50 V, I _D = - 2.2 A	1.1	-	-	S
Dynamic		•			ı		ı
Input Capacitance	C _{iss}		V 0 V	-	340	-	
Output Capacitance	C _{oss}		$V_{GS} = 0 \text{ V},$ $V_{DS} = -25 \text{ V},$		110	-	рF
Reverse Transfer Capacitance	C _{rss}	f = 1	0 MHz, see fig. 5	-	33	-	
Total Gate Charge	Qg			-	-	20	nC
Gate-Source Charge	Q _{gs}	V _{GS} = - 10 V	$V_{GS} = -10 \text{ V}$ $I_D = -3.9 \text{ A}, V_{DS} = -160 \text{ V},$ see fig. 6 and 13 ^b		-	3.3	
Gate-Drain Charge	Q _{gd}				-	11	
Turn-On Delay Time	t _{d(on)}				8.8	-	
Rise Time	t _r	V _{DD} = -	100 V, I _D = - 3.9 A,	-	27	-	no
Turn-Off Delay Time	t _{d(off)}	$R_g = \overline{18} \Omega$, $R_D = 24 \Omega$, see fig. 10^b		-	7.3	-	ns
Fall Time	t _f			-	19	-	
Internal Drain Inductance	L _D		Between lead, 6 mm (0.25") from		4.5	=	nЦ
Internal Source Inductance	L _S	package and die contact	center of	-	7.5	-	- nH
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	Is	MOSFET sym		-	-	- 3.6	A
Pulsed Diode Forward Current ^a	I _{SM}	integral reverse p - n junction diode		-		- 14	
Body Diode Voltage	V_{SD}	$T_J = 25$ °C	I_S = - 3.6 A, V_{GS} = 0 V^b	ı	-	- 6.3	V
Body Diode Reverse Recovery Time	t _{rr}	T 25 °C 1	3 0 A dl/dt - 100 A/vab	-	150	300	ns
Body Diode Reverse Recovery Charge	Q _{rr}	$T_J = 25 ^{\circ}\text{C}, I_F = -3.9 \text{A}, dI/dt = 100 \text{A/} \mu \text{s}^{\text{b}}$		-	0.97	2.0	μC
Forward Turn-On Time	t _{on}	Intrinsic turn-on time is negligible (turn-on is dominated by L _S and L _D)					

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. Pulse width \leq 300 µs; duty cycle \leq 2 %.

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

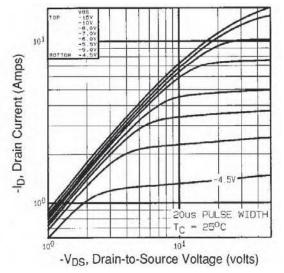


Fig. 1 - Typical Output Characteristics, T_C = 25 °C

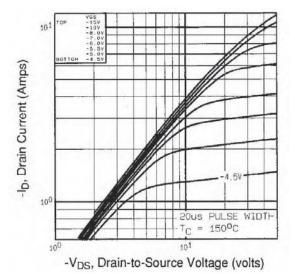


Fig. 2 - Typical Output Characteristics, T_C = 150 °C

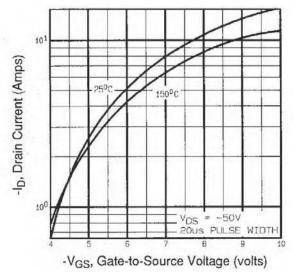


Fig. 3 - Typical Transfer Characteristics

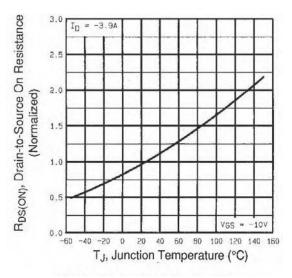


Fig. 4 - Normalized On-Resistance vs. Temperature

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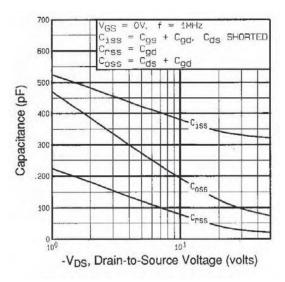


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

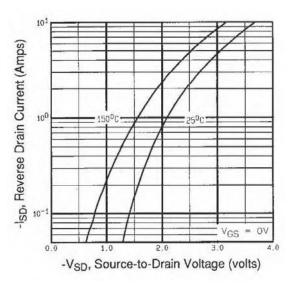


Fig. 7 - Typical Source-Drain Diode Forward Voltage

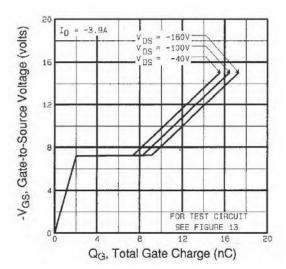


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

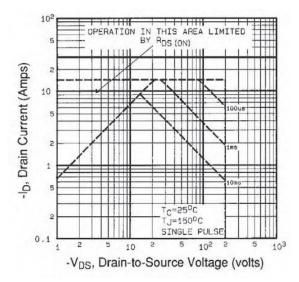


Fig. 8 - Maximum Safe Operating Area

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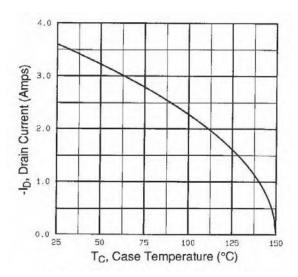


Fig. 9 - Maximum Drain Current vs. Case Temperature

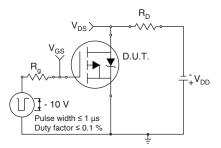


Fig. 10a - Switching Time Test Circuit

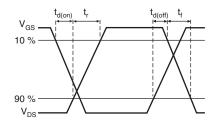


Fig. 10b - Switching Time Waveforms

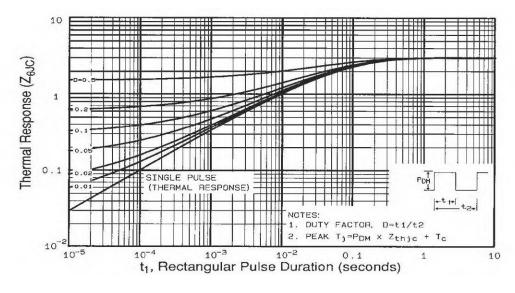
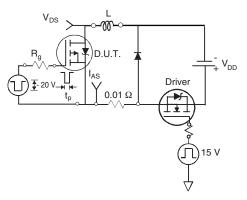


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

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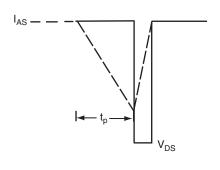


Fig. 12b - Unclamped Inductive Waveforms

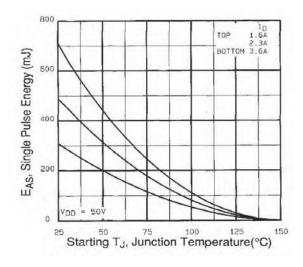


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

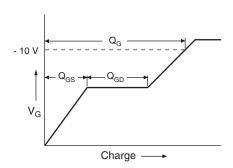


Fig. 13a - Basic Gate Charge Waveform

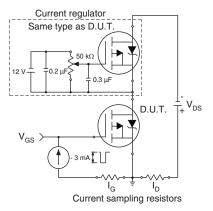
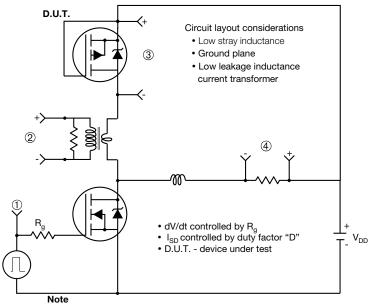


Fig. 13b - Gate Charge Test Circuit

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Peak Diode Recovery dV/dt Test Circuit



• Compliment N-Channel of D.U.T. for driver

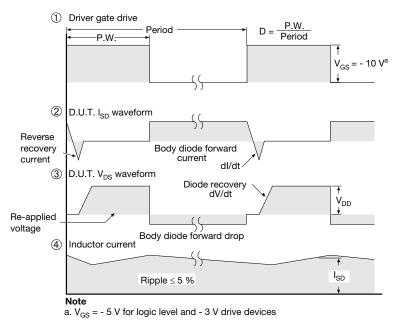


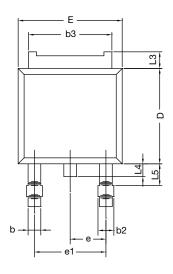
Fig. 14 - For P-Channel

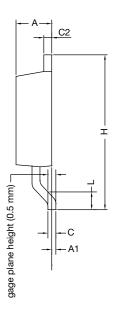
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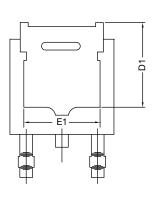


TO-252AA Case Outline

VERSION 1: FACILITY CODE = Y







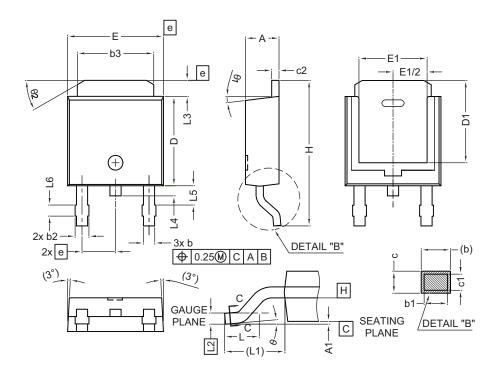
	MILLIMETERS		
DIM.	MIN.	MAX.	
A	2.18	2.38	
A1	-	0.127	
b	0.64	0.88	
b2	0.76	1.14	
b3	4.95	5.46	
С	0.46	0.61	
C2	0.46	0.89	
D	5.97	6.22	
D1	4.10	-	
Е	6.35	6.73	
E1	4.32	-	
Н	9.40	10.41	
е	2.28	BSC	
e1	4.56 BSC		
L	1.40	1.78	
L3	0.89	1.27	
L4	-	1.02	
L5	1.01	1.52	

Note

• Dimension L3 is for reference only



VERSION 2: FACILITY CODE = N



	MILLIMETERS			
DIM.	MIN.	MAX.		
Α	2.18	2.39		
A1	-	0.13		
b	0.65	0.89		
b1	0.64	0.79		
b2	0.76	1.13		
b3	4.95	5.46		
С	0.46	0.61		
c1	0.41	0.56		
c2	0.46	0.60		
D	5.97	6.22		
D1	5.21	=		
E	6.35	6.73		
E1	4.32	-		
е	2.29 BSC			
Н	9.94	10.34		

	MILLIMETERS			
DIM.	MIN.	MAX.		
L	1.50	1.78		
L1	2.74	ł ref.		
L2	0.51	BSC		
L3	0.89	1.27		
L4	-	1.02		
L5	1.14	1.49		
L6	0.65	0.85		
θ	0°	10°		
θ1	0°	15°		
θ2	25°	35°		

Notes

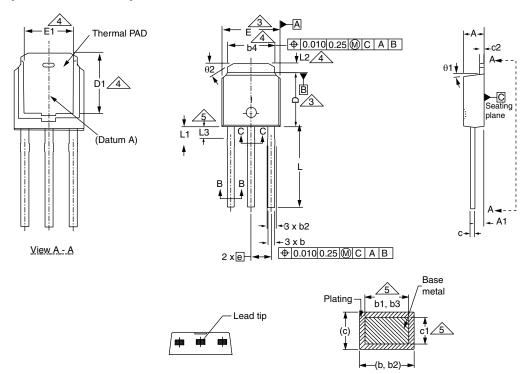
- Dimensioning and tolerance confirm to ASME Y14.5M-1994
- All dimensions are in millimeters. Angles are in degrees
- Heat sink side flash is max. 0.8 mm
- Radius on terminal is optional

ECN: E19-0649-Rev. Q, 16-Dec-2019

DWG: 5347



TO-251AA (HIGH VOLTAGE)



Section B - B and C - C

	MILLIMETERS		INC	HES
DIM.	MIN.	MAX.	MIN.	MAX.
Α	2.18	2.39	0.086	0.094
A1	0.89	1.14	0.035	0.045
b	0.64	0.89	0.025	0.035
b1	0.65	0.79	0.026	0.031
b2	0.76	1.14	0.030	0.045
b3	0.76	1.04	0.030	0.041
b4	4.95	5.46	0.195	0.215
С	0.46	0.61	0.018	0.024
c1	0.41	0.56	0.016	0.022
c2	0.46	0.86	0.018	0.034
D	5.97	6.22	0.235	0.245

	MILLIMETERS		INC	HES
DIM.	MIN.	MAX.	MIN.	MAX.
D1	5.21	-	0.205	-
Е	6.35	6.73	0.250	0.265
E1	4.32	-	0.170	-
е	2.29 BSC		2.29 BSC	
L	8.89	9.65	0.350	0.380
L1	1.91	2.29	0.075	0.090
L2	0.89	1.27	0.035	0.050
L3	1.14	1.52	0.045	0.060
θ1	0'	15'	0'	15'
θ2	25'	35'	25'	35'

ECN: S-82111-Rev. A, 15-Sep-08

DWG: 5968

Notes

- 1. Dimensioning and tolerancing per ASME Y14.5M-1994.
- 2. Dimension are shown in inches and millimeters.
- 3. Dimension D and E do not include mold flash. Mold flash shall not exceed 0.13 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body.
- 4. Thermal pad contour optional with dimensions b4, L2, E1 and D1.
- 5. Lead dimension uncontrolled in L3.
- 6. Dimension b1, b3 and c1 apply to base metal only.
- 7. Outline conforms to JEDEC outline TO-251AA.

Document Number: 91362 Revision: 15-Sep-08



RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)



Recommended Minimum Pads Dimensions in Inches/(mm)

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APPLICATION NOTE



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IRFR9220TRR IRFU9220 IRFU9220PBF SIHFU9220-GE3